

Cleaning wipes – ready-to-use

SYS-CLEAN[®] WIPES1.0 are special cleaning wipes for the pre-cleaning of SMT print stencils and other stainless steel surfaces, as well as squeegees, spatulas etc.

SYS-CLEAN[®] WIPES1.0 are impregnated with an optimized water-based cleaning medium and are ready for immediate use. The unobtrusive smell makes handling pleasant.

The cleaner used in **SYS-CLEAN[®] WIPES1.0** is identical with our **SYS-CLEAN[®] STC1.0**.



Application

Pollution	Suitability
Solder pastes	✓
SMT adhesive or conductive adhesive	✓
Flux	✓ ✓
Oils/fats	✓

✓ ✓ = Excellent ✓ = Optimal ○ = Optional ✗ = Not recommended

Specifications

SYS-CLEAN[®] Wipes1.0 are delivered in dispenser cans and refill packs.

pH-Value	6,1
Density (at 20°C)	0,999 g/cm ³
Refractive Index (at 20°C)	N.A.
Initial boiling point and boiling range	>100 °C
Flashpoint	100 °C

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Application	
Spray-in-air	✘
Immersion cleaning air agitated	✘
Spray under Immersion	✘
Ultrasonic	✘
Manual cleaning	✓ ✓

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Vorteile:

The wipes are ideal for cleaning uncured adhesives and pastes.

Your attention, please:

Do not use the wipes on painted surfaces.

Availability:

SYS-CLEAN[®] WIPES1.0 are available in the following sizes

Item number for dispenser box: 64903543

Item number for refill pack : 64903626



Registration, Evaluation and
Authorisation of Chemicals

The product is free of
questionable ingredients
according to the SIN- &
SVHC-Lists



100% compliant with EU
guidelines RoHS 1 & 2,
WEEE